



REV.	REVISIONS REC.	DATE	REV.	REVISIONS REC.	DATE
2	(H):5.15->5.25; (H1):2.75->2.85	'04.05.13	5	過線槽結構設變如注記 5	'04.06.01
3	(M):1.25->1.00±0.1	'04.05.13	6	6 :1.9->2.1	'05.04.16
4	過線槽結構設變如注記 4	'04.05.13	7	端子材質硬度由:1/2H->H	'06.04.17

DRAWN & DRAFTED BY HOU YI MIN	TOLERANCES		ANGLE: ±1°	TITLE: SMD BOBBIN UI-9.8-C	
	0<L≤4 ±0.1	COPLANARITY 0.1 MAX	UNIT: MM	BOBBIN MATERIAL: LCP E4008	UL REC. UL 94V-0
CHECKED & APPROVED BY	4<L≤16 ±0.2		ORIGIN: SZ	PIN MATERIAL: PHOSPHOR BRONZE(H)	PIN TENSION LOAD: 2.0KG MIN
PIN SHINE INDUSTRIAL CO.,LTD. TEL:886-2-22990545 FAX:886-2-22990546			DATE: APR.17 '2006	DRAWING NO. S-902-1	REV. 7